## SPINDLE MOTOR DRIVER

The KA3016D is a monolithic integrated circuit, suitable for a 3-phase spindle motor drive of a CD system.

#### **FEATURES**

- 3-phase, full-wave, linear BLDC motor driver
- Power save at stop mode
- Built-in current limiter
- Built-in TSD (Thermal shutdown) circuit
- Built-in 3X or 1X hall FG output
- Built-in hall bias circuit
- Built-in rotational direction detector
- Built-in reverse rotation preventer
- Built-in short braker
- WWW.DZSC.COM Corresponds to 3.3V or 5V DSP

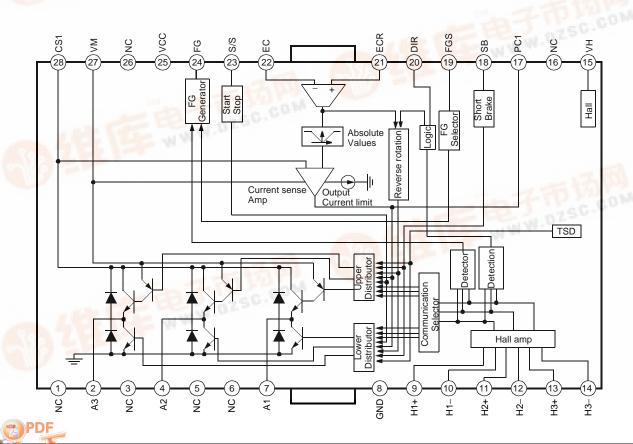


## ORDERING INFORMATION

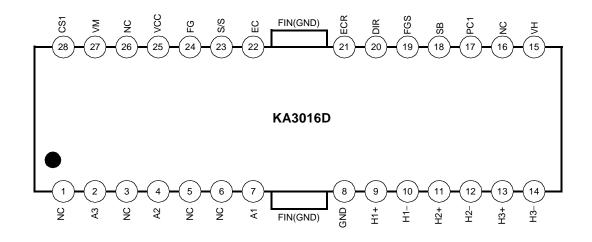
Device	e Package Operating Tempera	
KA3016D	28-SSOPH-375	–25°C ~ +75°C

## **BLOCK DIAGRAM**

WHECHILD



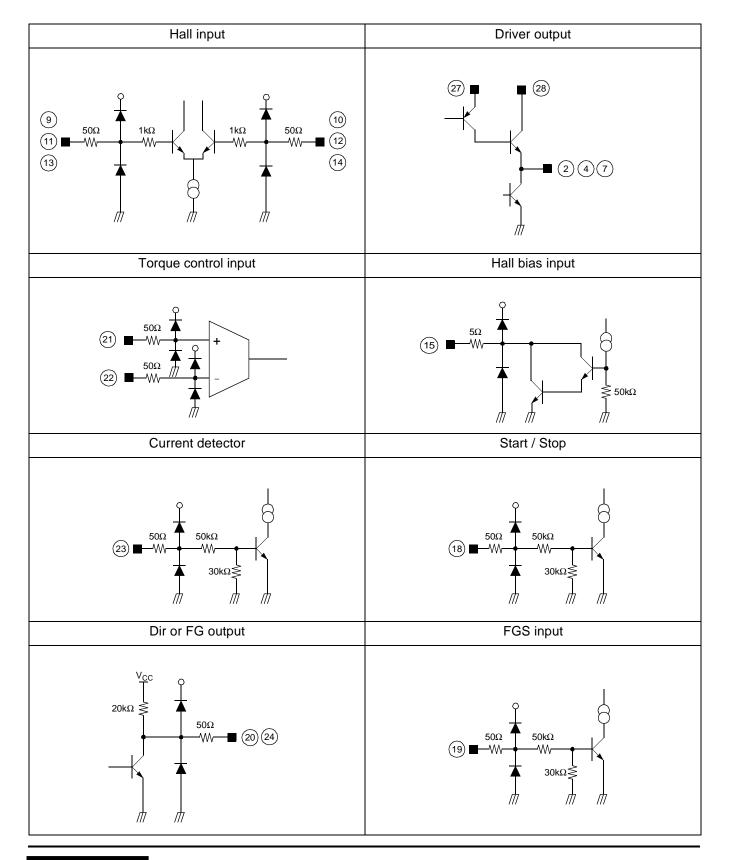
# **PIN CONFIGURATION**



# **PIN DESCRIPTIONS**

Pin No.	Symbol	I/O	Description	Pin No.	Symbol	I/O	Description
1	NC	_	No connection	15	VH	I	Hall bias
2	А3	0	Output (A3)	16	NC	_	No connection
3	NC	_	No connection	17	PC1	_	Phase compensation capacitor
4	A2	0	Output (A2)	18	SB	I	Short brake
5	NC	_	No connection	19	FGS	I	Frequency generation selection
6	NC	_	No connection	20	DIR	0	Rotational direction output
7	A1	0	Output (A1)	21	ECR	I	Output current control reference
8	GND	_	Ground	22	EC	I	Output current control voltage
9	H1+	I	Hall signal (H1+)	23	S/S	I	Power save (Start/Stop switch)
10	H1–	I	Hall signal (H1-)	24	FG	0	Frequency generation waveform (3X or 1X hall frequency)
11	H2+	I	Hall signal (H2+)	25	VCC	_	Supply voltage (Signal)
12	H2-	I	Hall signal (H2-)	26	NC	_	No connection
13	H3+	I	Hall signal (H3+)	27	VM	_	Supply voltage (Motor)
14	H3-	I	Hall signal (H3–)	28	CS1	-	Output current detection

## **EQUIVALENT CIRCUITS**

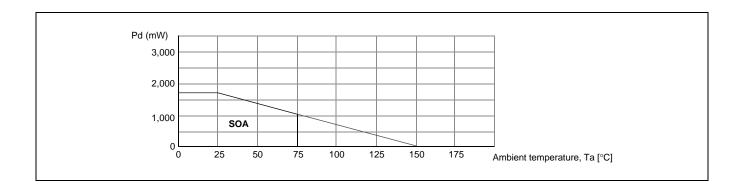


# ABSOLUTE MAXIMUM RATING (Ta=25°C)

Characteristics	Symbol	Value	Unit
Maximum supply voltage (Signal)	V <sub>CCMAX</sub>	7	V
Maximum supply voltage (Motor)	$V_{MMAX}$	18	V
Power dissipation	P <sub>D</sub>	1.7 <sup>note</sup>	W
Maximum output current	I <sub>OMAX</sub>	1.3	А
Operating temperature range	T <sub>OPR</sub>	−25 ~ <b>+</b> 75	°C
Storage temperature range	TSTG	−55 ~ <b>+</b> 150	°C

#### NOTE:

- 1. When mounted on 76.2mm × 114mm × 1.57mm PCB (Phenolic resin material)
- 2. Power dissipation is reduced 13.6 mV / °C for using above Ta=25°C
- 3. Do not exceed Pd and SOA (Safe operating area).



# RECOMMENDED OPERATING CONDITIONS

Characteristics	Symbol	Min.	Тур.	Max.	Unit
Supply voltage	V <sub>CC</sub>	4.5	5	5.5	V
Motor supply voltage	V <sub>M</sub>	3.0	12	15	V



# **ELECTRICAL CHARATERISTICS**

(Unless otherwise specified, Ta=25°C,  $V_{CC}$ =5V,  $V_{M}$ =12V)

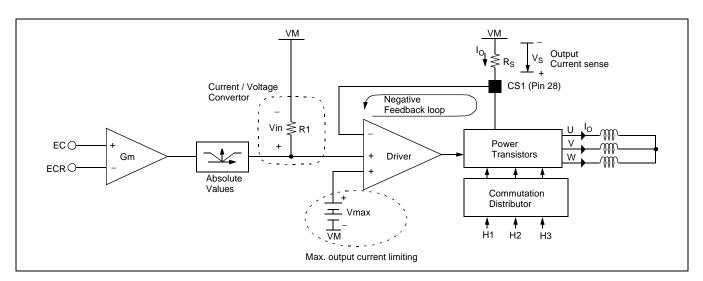
Characteristics	Symbol	Test conditions	Min.	Тур.	Max.	Unit	
Quiescent circuit current	I <sub>CC</sub>	-	2	5	8	mA	
START / STOP							
On voltage range	V <sub>SSON</sub>	Output drive on	2.5	_	V <sub>CC</sub>	V	
Off voltage range	V <sub>SSOFF</sub>	Output driver off	0.0	-	1.0	V	
HALL BIAS	ı		1	l			
Hall bias voltage	$V_{HB}$	I <sub>HB</sub> =20mA	0.4	1.0	1.8	V	
HALL AMP	ı		1	l			
Hall bias current	I <sub>HA</sub>	_	_	0.5	2	μΑ	
Common mode input range	$V_{HAR}$	-	1.5	_	4.0	V	
Minimum input level	V <sub>INH</sub>	-	100	-	_	mVpp	
TORQUE CONTROL	ı		1	l			
E <sub>CR</sub> input voltage range	E <sub>CR</sub>	_	0.2	_	4.0	V	
E <sub>C</sub> input voltage range	E <sub>C</sub>	_	0.2	-	4.0	V	
Offset voltage (-)	E <sub>COFF</sub>	E <sub>C</sub> =2.5V	-80	-50	-20	mV	
Offset voltage (+)	E <sub>COFF+</sub>	E <sub>C</sub> =2.5V	20	50	80	mV	
E <sub>C</sub> input current	E <sub>CIN</sub>	E <sub>C</sub> =2.5V	-5	0.5	5	μΑ	
E <sub>CR</sub> input current	E <sub>CRIN</sub>	E <sub>CR</sub> =2.5V	-5	0.5	5	μΑ	
In/output gain	G <sub>EC</sub>	$E_{CR}$ =2.5V, $R_{CS}$ =0.5 $\Omega$	0.41	0.51	0.61	A/V	
FG							
FG output voltage (H)	$V_{FGH}$	I <sub>FG</sub> = -10μA	3.0	_	V <sub>CC</sub>	V	
FG output voltage (L)	$V_{FGI}$	I <sub>FG</sub> =10μA	_	_	0.5	V	
Input voltage range		_	_	50	_	%	
OUTPUT BLOCK							
Saturation voltage (upper TR)	V <sub>OH</sub>	I <sub>O</sub> = -300mA	_	0.9	1.6	V	
Saturation voltage (lower TR)	V <sub>OL</sub>	I <sub>O</sub> =300mA	_	0.2	0.6	V	
Torque limit current	I <sub>TL</sub>	R <sub>CS</sub> =0.5Ω	560	700	840	mA	
DIRECTION DETECTOR			•				
Dir output voltage (H)	V <sub>DIRH</sub>	I <sub>FG</sub> =-10μA	3.0	_	V <sub>CC</sub>	V	
Dir output voltage (L)	$V_{DIRL}$	I <sub>FG</sub> =10μA	_	_	0.5	V	

# **ELECTRICAL CHARATERISTICS (Continued)**

(Unless otherwise specified, Ta=25°C,  $V_{CC}$ =5V,  $V_{M}$ =12V)

Characteristics	Symbol	Test conditions	Min.	Тур.	Max.	Unit
FG SELECTION	<b>'</b>		<b>-</b>	•	ı	l
3X frequency selection	V <sub>FG3X</sub>	FGS > 2.5V	2.5	_	V <sub>CC</sub>	V
1X frequency selection	V <sub>FG1X</sub>	FGS < 1.0	_	_	1.0	V
SHORT BRAKE			•	•	•	
On voltage range	V <sub>SBON</sub>	_	2.5	_	V <sub>CC</sub>	V
Off voltage range	V <sub>SBOFF</sub>	_	0	_	1.0	V

## **CALCUALTION OF GAIN & TORQUE LIMIT CURRENT**



0.255 which is made from GM times R1 is fixed value within IC.

$$Gain = \frac{0.255}{R_S}$$

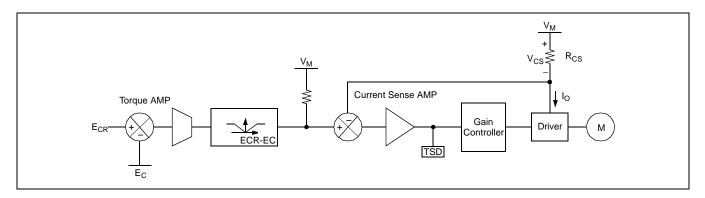
Vmax (see above block diagram) is setted to 350mV.

$$Itl[mA] = \frac{Vmax}{R_S} = \frac{350[mV]}{R_S}$$

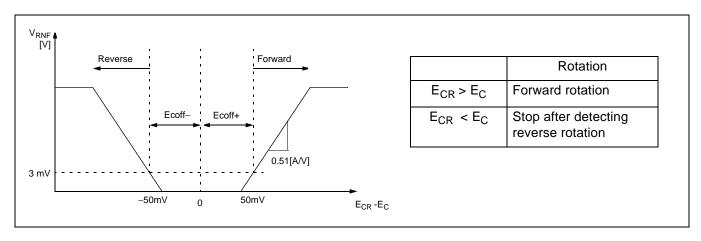


#### **APPLICATION INFORMATION**

#### 1. TORQUE CONTROL & OUTPUT CURRENT CONTROL

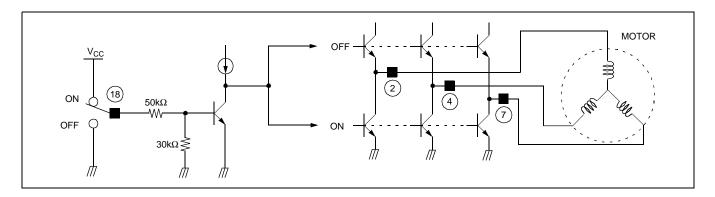


- By amplifying the voltage difference between E<sub>C</sub> and ecr from servo IC, the torque sense amp produces the input (V<sub>AMP</sub>) for the current sense amp.
- The output current (I<sub>O</sub>) is converted into the voltage (V<sub>CS</sub>) through the sense resistor (R<sub>CS</sub>) and compared with the V<sub>AMP</sub>. By the negative feedback loop, the sensed output voltage, V<sub>CS</sub> is equal to the input V<sub>AMP</sub>.
   Therefore, the output current (I<sub>O</sub>) is linearly controlled by the input V<sub>AMP</sub>.
- As a result, the signals, E<sub>C</sub> and E<sub>CR</sub> can control the velocity of the Motor by controlling the output current (I<sub>O</sub>) of the Driver.
- The range of the torque voltage is as shown below.



The input range of  $E_{CR}$ ,  $E_C$  is 0.2V ~ 4V.

#### 2. SHORT BRAKE

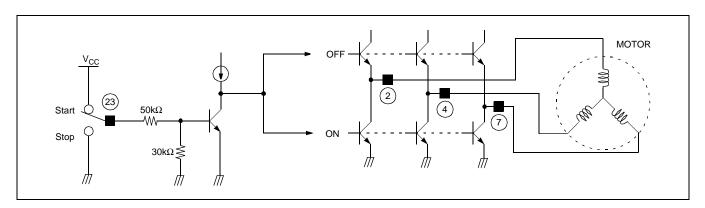


Pin # 18	Short brake
High	On
Low	Off

When the pick-up part moves from the inner to the outer spindle of the CD, the brake function of the reverse voltage is commonly employed to decrease the rotating velocity of the spindle motor. However, if the spindle motor rotates rapidly, the brake function of the reverse voltage may produce much heat at the Drive IC.

To remove this shortcoming and to enhance the braking efficiency, the short brake function is added to KA3016D. When the short brake function is active, all upper power TRs turn off and all lower power TRs turn on, so as to make the rotating velocity of the Motor slow down. But FG and DIR functions continue to operate normally.

## 3. POWER SAVE

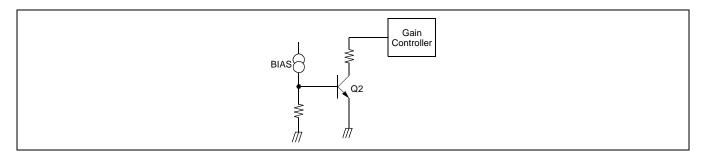


Pin # 23	Start/Stop
High	Operate
Low	Stop

When power save function active, all power TRs turn off but FG and DIR functions continue to operate normally.

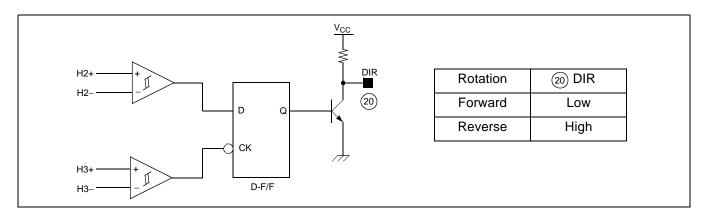


## 4. TSD (THERMAL SHUTDOWN)

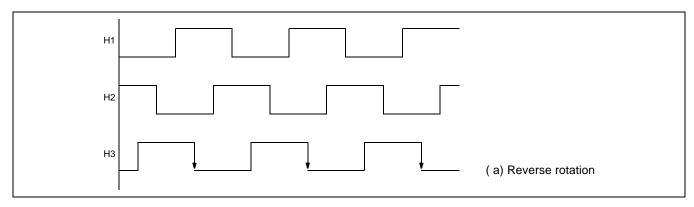


When the chip temperature rises up to about  $175^{\circ}$ C, the Q2 turns on so that the output driver will be shutdown. When the chip temperature falls off to about  $150^{\circ}$ C, then the Q2 turns off so that the driver is to operate normally. Thus, TSD has the temperature hysteresis of about  $25^{\circ}$ C.

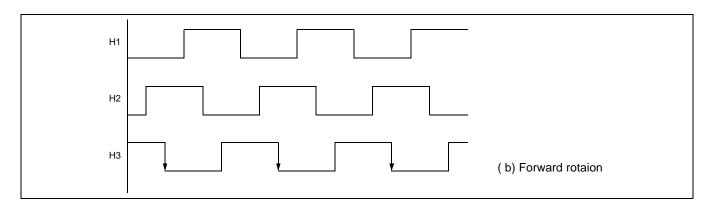
#### 5. ROTATIONAL DIRETION DETECTION



- The forward and the reverse rotations of the CD are simply detected by using the D-F/F and the truth table is shown in the above table.
- The rotational direction of the CD can be explained by the output waveforms of the hall sensors. Let the three outputs of hall sensors be H1, H2 and H3 respectively.
   When the spindle rotates in reverse direction, the hall sensor output waveforms are shown in Fig.(a). Thus the phases orderd in H1→H2→H3 with a 120°C phase difference.



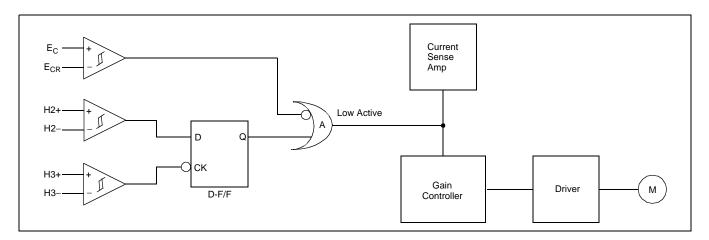
On the other hand, if the spindle rotates in forwand rotation, the phase relationship is  $H3\rightarrow H2\rightarrow H1$  as shown in fig.(b).



Therefore, the output of the rotational direction detector is low, when the spindle rotates forward, while high as in the case of the reverse rotation.

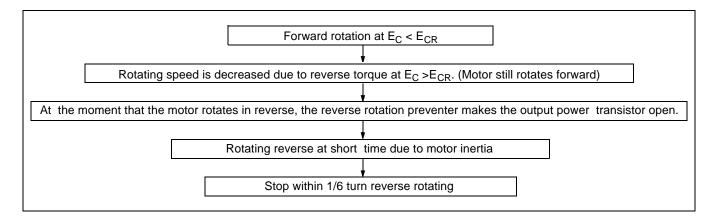


#### 6. REVERSE ROTATION PREVENTION

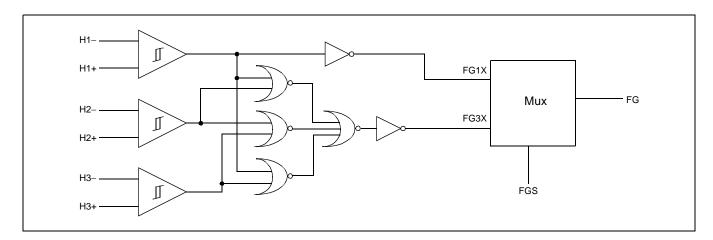


- When the output of the OR Gate, A is low, it steers all the output current of the current sense amp makes the
  current delivered to the gain controller zero. Thus the output current of the driver becomes zero and the motor
  is stopped.
- As in the state of the forward rotation, the D-F/F output, Q is high and the motor rotates normally. At this state if
  the control input is changed such that E<sub>C</sub>>E<sub>CR</sub>, then the motor rotates slowly more and more by the reverse
  commutation in the driver. At the moment that the motor rotates in reverse direction, the D-F/F output becomes
  low and the OR gate output, thus, becomes low. This prevents the motor from rotating in reverse direction.
  The operation principle is shown in the table and the flow chart..

Rotation	H2	H3	D-F/F	Reverse rotat	tion preventer
			(Q)	E <sub>C</sub> >E <sub>CR</sub>	E <sub>C</sub> >E <sub>CR</sub>
Forward	Н	H→L	Н	Forward	_
Reverse	L	H→L	L	_	Brake and stop

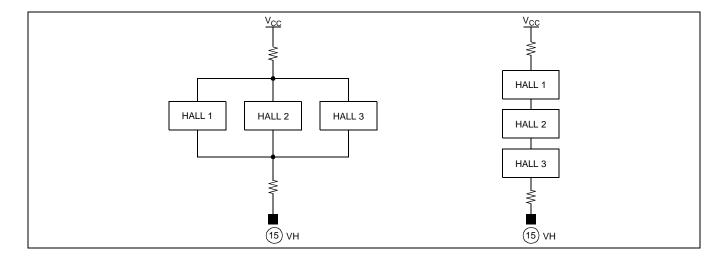


## 7. FG OUTPUT

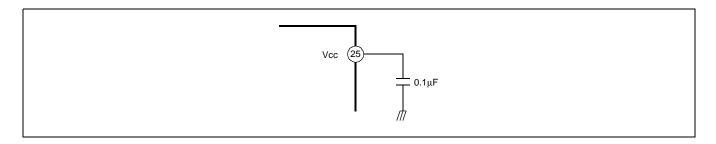


FGS	FG
GND or Open	FG1X (1X hall frequency)
V <sub>CC</sub>	FG3X (3X hall frequency)

## 8. HALL SENSOR CONNECTION



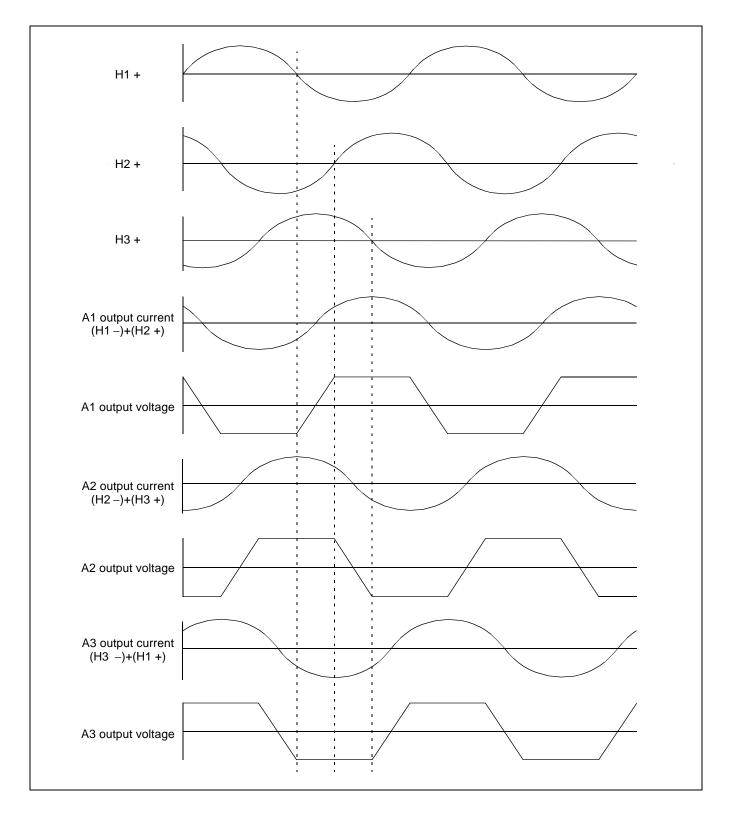
9. Connect a by-pass capacitor, 0.1 $\mu\text{F}$  between the supply voltage source.



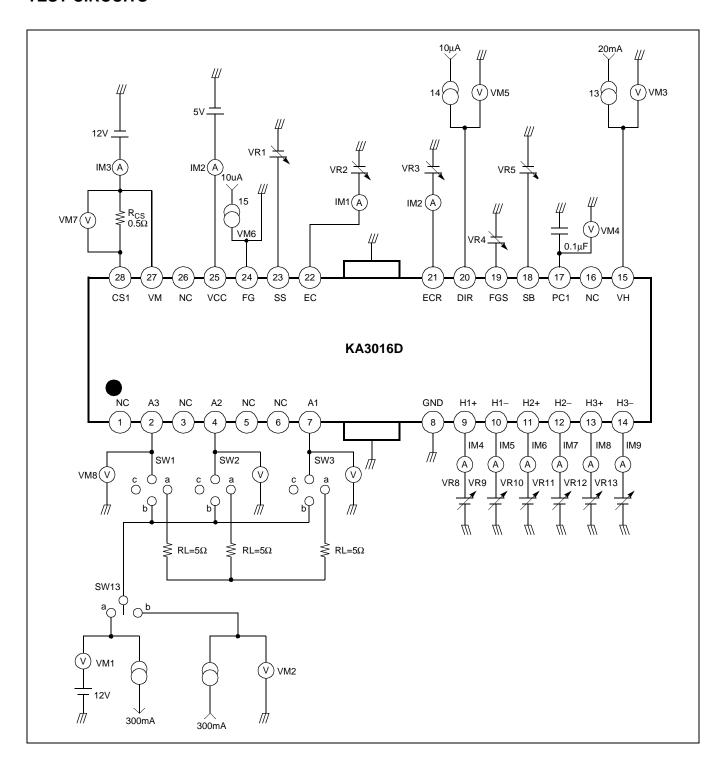
10. The heat radiation fin is connected to the internal GND of the package. Connect that fin to the external GND.



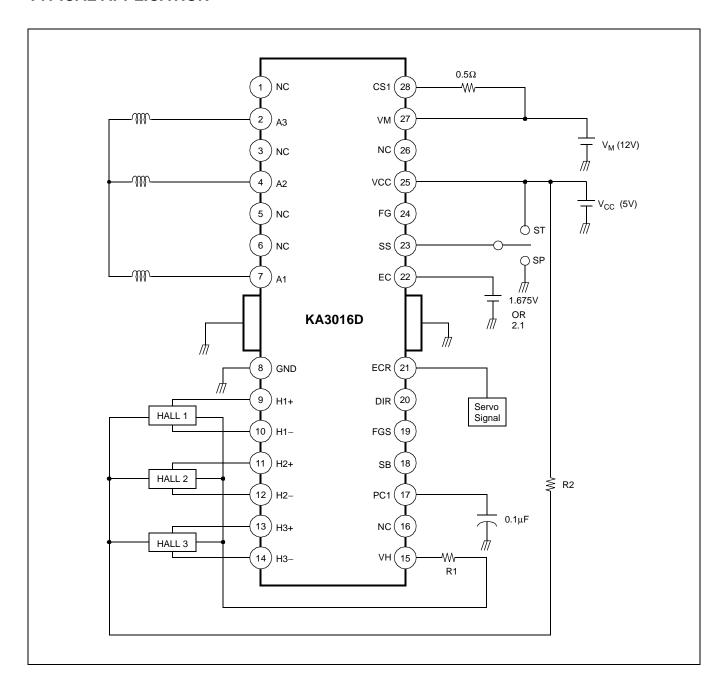
## 11. INPUT-OUTPUT TIMING CHART



## **TEST CIRCUITS**

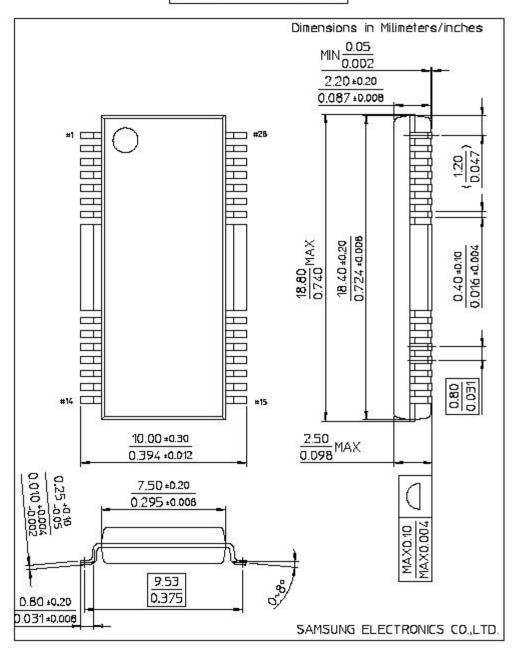


# **TYPICAL APPLICATION**



## PACKAGE DIMENSION

# 28-SSOPH-375



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